SPECIFICATION

For

EG4801S-AR

This specification consists of two documents as follows.

1.LCD Specification SC-010006500

2.LCD QA Standard M3-00100

Customer's Approval	
Date By	Date Feb. 4 '93 Presented by
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Spec Code

S C - 010006500

LD DESIGN Dep.

M. Niyashita

K. Udiposta Aue State

SPECIFICATIONS

EG4801S-AR

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1-1 Display Specifications	
(1) STN Mode Positive Display type Reflective Model	
(2) Display Color	
Display Color : Display Data"1" : Dark Blue Background Color : Display Data"0" : Gray	
(3) Viewing Angle : 6 O'clock direction	
(4) Driving Duty : 1/64 Duty	
 Color tone is slightly changed by temperature and driving voltage. 	
1-2 Mechanical Specifications	
(1) Outline Dimensions : Refer to attached Outline Dimensions figure $SD - 0 \ 1 \ 0 \ 0 \ 5 \ -$	A
(2) Dot Matrix : 512 dots \times 128 dots	
(3) Dot Size : 0. 4 3 (W) \times 0. 4 3 (H) (mm)	
(4) Dot Pitch : 0.47 (W) × 0.47 (H) (mm)	
(5) Weight : 3 2 0 g (Approx.)	
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SEIKOEPSON CORPORATION Sheet 11-0100065	



1-4 Terminal Functions

Pin No.	Symbol Symbol	Function
1	VDD	Power supply for logic
2	VSS	Ground
3	VLCD	Power supply for LCD
4	LP	Latch pulse signal input
5	FR	Switch signal input to convert LC drive waveform to AC
6	YDIS	Display control (Display off "0", Normal state "1")
7	Y SCL	Row scan shift clock input
8	DIN	Row scan start-up pulse input
9	X SCL	Display data shift clock input
10	X ECL	Enable transition clock input
	D 0	
14	D 3	Display data pulse input

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2. Absolute Maximum Ratings

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ltem	Symbol	Standard Value	Unit	Condition	
Power supply Voltage	VDD-VSS	$0 \sim +7.0$			
LCD Driving Voltage	VDD - VLCD	0 ~ + 2 5. 0	v		
Input Voltage	VIN	$VSS \leq VIN \leq VDD$			
Operating Temperature Range	TOP	0 ~ +50			
Storage Temperature Range	TST	$-20 \sim +60$	°C	Not to be dewy	



Sheet Code 21-C0000001

3. Electrical Characteristics

3-1 DC Characteristics

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(1) Module DC Characteristics

T a = 0 ~ 5 0 °C, VDD = 5 V \pm 5 %

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Sheet Code

Item	Symbol	St	tandard Va	lue			
	Gyübbi			MAX	Unit	Applicable Terminal	Condition
Power Supply	V DD	4. 75	5.0	5.25		VDD	
Voltage	VDD-VLCD	Depending Optical C	on Characteris	stics	V	VLCD	-
"O"Input Voltage	VIL	0	-	0. 2VDD	+	LP, FR	
"1"Input Voltage	VIH	0. 8VDD		YDD		YDIS, YSCL DIN, XSCL	
I/O Leak Current	IL	_	-	50	μA	XECL D0~D3	
Power Supply Current	I DD	_	-	8	mA	VDD	
LCD Power Supply Current	I LCD	-	_	5	mA	VLCD	*1

*1) VLCD=-8V. Frame Frequency 60Hz

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31-010006500

3-2 AC Characteristics

Item	Symbol	St	andard Va	lue	Unit	Constitution	
	Symbol .	ΜΙΝ	ТҮР	MAX	- Unit	Condition	
Allowable F R Delay Time	TFD	- 5 0 0	0	500	лѕес		
LP, YSCL Period	TLC	_	220	- T	µ sec		
XSCL Period	TXSC	166	_	-	nsec		
YSCL "L" Time	TSL	180		-	nsec		
YSCL Pulse Width	WYSC	180	_	-	nsec		
LP"L" Time	TLL	220		-	nsec		
L P Pulse Widhte	WLP	250	<u> </u>		пѕес		
XECL L Time	TEL	100	_	-	nsec		
XECL Pulse Width	WECL	100	_	_	nsec		
XSCL "L" Time	TXSL	63	-	_	nsec		
XSCL Pulse Width	WXSC	63	-	-	nsec	V D D =	
XECL Setup Time	TL1	140	-	_	nsec		
XECL Hold Time	TL2	50			nsec	5 V	
	TLT1	125	_	_	11		
Latch Timing	TLT2	0	_		1		
Daten Himing	TLS1	100	_	_	nsec		
	TLS2	0		-			
XECL Switching Time ("H")	T S I	70	-	_	nsec		
XECL Switching Time ("L")	T S 2	-10	-	_	nsec	ù.	
Data Setup Time	TDS	50	-	-	nsec		
Data Hold Time	ТДН	30	-		nsec		
D I N Setup Time	TDIS	100	-	-	nsec		
DIN Hold Time	TDIH	30	_	-	nsec		
nput Wave Form Rise Time	tr	-	-	× 1	nsec		
nput Wave Form Fall Time	t f	-	-	× 1	nsec		

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3-5 Relation between Data and Display

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1: 1	1: 2	1: 3	1: 4	1	:509 1:510	1:511	1:512
2: 1	2: 2	2: 3	.		. 2:510	2:511	2:512
3: 1	3: 2				• •	3:511	3:512
4: 1		•				•	4:512
61: 1							C1 C10
		<u> </u>			• • •	·	61:512
	62: 2	·	•		· .	62:511	62:512
63: 1	63: 2	63: 3	•		. 63:510	63:51ľ	63:512
64: 1	64: 2	64: 3	64:4	64	:509 64:510	64:511	64:512
1:513	1:514	1:515	1:516	1	:1021 1:1022	1:1023	1:1024
2:513	2:514	2:515			2:1022	2:1023	2:1024
3:513	3:514				• •	3:1023	3:1024
4:513	•					•	4:1024
61:513		•	•				61:1024
62:513	62:514		•		•	62:1023	62:1024
63:513	63:514	63:515	,		63:1022	63:1023	63:1024
64:513	64:514	64:515	64:516	64:	1021 64:1022	64:1023	64:1024

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4. Optical Characteristics

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4-1 Optical Characteristics

f FR = 75 H z

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Item	Symbol	Tomp	St	tandard Val	ue		Condition	
	Gyüldül	Temp ℃	MIN	ТҮР	MAX	Unit		
		0	-	14.6	15.6			
Driving Voltage	VOP	25	—	13.6	-	v		
		50	11.3	12.3				
Response Time	Tr		_	300	600			
		25		100	200	1		
	T f	0	_	500	1000	ms		
		25	-	150	300	1		
	θY1		20	-				
Viewing Angle	θY2	25	30		_			
	θX1	20	25	_		DEG	K ≥ 2	
	θX2		25	_				
Contrast	к	25	-	3	<u> </u>			

*1) Vop=LCD Driving Voltage getting maximum contrast = YDD-YLCD

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5. Reliability

5-1 Content of Reliability Test

		Environmental Test								
No	Test Item	Connect of Test lest Condition								
1	High temperature storage	Endurance test applying the high storage temperature for a long time.	60 °С 200 Н							
2	Low temperature storage	Endurance test applying the low storage temperature for a long time.	-20 °С 200 Н							
3	High temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50 °С 200 н							
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	0 °C 200 H							
5	High temperature/ humidity storage	Endurance test applying the high temperature and high humidity storage for a long time.	60 ℃ 90 %RH 96 H	MIL-202E-103B JIS-C5023						
6	High temperature/ humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature/humidity stress to the element for a long time.	50 ℃ 90 %RH 96 H	MIL-202E-103B JIS-C5023						
7	Temperature cycle									
		l cycle								
		Mechanical Test		I						
8	Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mm 22~500Hz →1.5 Total 0.5H	р-р MiL-202E-201A G JIS-C5025 JIS-C7022-A-10						
9	Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign w llmsec 3 times of each direction							
0	Atmospheric pressure test	Atmospheric pressure testEndurance test applying the atmospheric pressure during transportation by air.115 mbar 40 11								
	<u> </u>	Others	<u>.</u>							
1	Static electricity test	Endurance test applying the electric stress to the terminal.	VS = 800 v RS = 1.5 kΩ CS = 100 PF 1 time	MIL-883B-3015.						
	rower supply	ion for operation test voltage for Logic system = 5V voltage for LCD system = Getting Opti	mum Contrast at	25°C						
			··· •							
	SEIKO	EPSON corporat		Sheet						



5-2 Failure Judgement Criterion

Criterrion	Ĺ	Test Item No.												
Item	1	2	3	4	5	6	7	8	9	10	11	Failure Judgment Criterion		
Basic Specification	0	0	0	0	0	0	0	0	0	0	0	Out of the Basic Specification		
Electrical characteristic	0		0	0	0	0					0	Out of the DC and AC Characteristic		
Mechanical characteristic						0	0	0	0			Out of the Mechanical Specification Color change : Out of Limit Apperance Specification		
Optical characteristic	0	0	0	0	0	0	0			0	0	Out of the Apperance Standard		

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Precautions for use of	Deb modules		
<handling precautions=""></handling>		-	
 The display panel is by dropping it from a 	made of glass. Do not subje high place, etc.	ect it to a mechanic	al shock
be sure not to get an	is damaged and the liquid cr y in your mouth. If the sub promptly wash it off using s	stance comes into co	ide it leaks ou ontact with
• Do not apply excessive since this may cause	e force to the display surfa the color tone to vary.	ce or the adjoining	areas
 The polarizer covering easily scratched. Has 	g the display surface of the ndle this polarizer carefull	LCD module is soft y.	and
 If the display surface wipe it with a soft dr with one of the follow 	e becomes contaminated, brea y cloth. If it is heavily ying solvents.	the on the surface a contaminated, moiste	ind gently en cloth
- Isopropyl alcohol - Ethyl alcohol			
Solvents other than th Especially, do not use	ose mentioned above may dama the following.	age the polarizer.	
- Water - Ketone - Aromatic solvents			
 Exercise care to minim is accelarated by wate in a high-humidity env 	ize corrosion of the electro r droplets, moisture condens ironment.	de. Corrosion of t ation or a current	he electrodes flow
make sure that It IS I	by using the mounting holes ree of twisting, warping, an forcibly pull or bend the I/	d distortion	
• Do not attempt to disa	ssemble or process the LCD M	odule.	
• NC terminal should be o	open. Do not connect anythi	ng.	•
	ower is off, do not apply th		
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an optimum work environment.	
• Be sure to ground the body when handling the LCD Modules.	•
 Tools required for assembly, such as soldering irons, must be 	properly grounded.
 To reduce the amount of static electricity generated, do not and other work under dry conditions. 	conduct assembly
 The LCD Module is coated with a film to protect the display su Exercise care when peeling off this protective film since sta- may be generated. 	urface. tic electricity
<storage precautions=""></storage>	
• When storing the LCD Modules, avoid exposure to direct sunlight or fluorescent lamps. Keep the modules in bags designed to prevent st charging under low temperature/normal humidity conditions (avoid hi high humidity and low temperatures below 0 °C). Whenever possible, should be stored in the same conditions in which they were shipped	tatic electricity gh temperature/ the LCD Modules
<design precaustions=""></design>	
 The absolute maximum ratings represents the rated value beyond whic cannot exceed. When the LCD Modules are used in excess of this rat their operating characteristics may be adversely affected. 	ch LCD Modules ed value.
 To prevent the occurrence of erroneous operation caused by noise, a paied to satisfy VIL, VIH, and the other specification values, including taking the precaution of using signal cables that are sho 	
• The liquid crystal display exhibits temperature dependency characte Since recognition of the display becomes difficult when the LCD is designated operating temperature range, be sure to use the LCD with Also, keep in mind that the voltage levels necessary for clear disp will vary according to temperature.	used outside its
 If DC is impressed on the liquid crystal display panel, display def deteriorated by the electrochemical reaction that occurs inside the To eliminate the opportunity of DC impressing, be sure to maintain of the input signals sent to the LCD Module (especially, LP, DIN, and 	liquid crystal pane the AC characteristic
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<Others>

• Liquid crystals solidify under low temperatures (below the storage temperature range) leading to defective orientation or the generation of air bubbles (balck or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.

• If the LCD Wodules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time.

It should be noted that this phenominon does not advesely affect performance reliability.

• To minimize the performance degradation of the LCD Modules resulting from destruction caused by static electricity, etc., exercise care to avoid holding the following sections when handling the modules.

• Exposed area of the printed circuit board

• Terminal electrode sections

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REV.	Revision I	tems Date
_	NEW	1993. 1.2
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